Gas Discharge Tubes SL1003A Series



Electrical Characteristics

	Device Specifications (at 25°C)						Life Ratings							
Part Number	DC Breakdown in Volts ^{1,2,3} (@100V/s)		Impulse Breakdown in Volts ^{2,3} (@100V/µs)	Impulse Breakdown In Volts ^{2,3} (@1kV/µs)	Insulation Resistance	tance (@1MHz	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@200A 10/1000µs)	Nominal Impulse Discharge Current (8/20µs)	Nominal AC Discharge Current (10x1s @50Hz)	AC Discharge Current (9 Cycles @ 50Hz)	DC Holdover Voltage ⁴	Max Impulse Discharge Current (1 Application)	
	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP	@ 10/350µs
SL1003A090	72	90	108		700	10 ⁹ Ω 10 ⁹ Ω (at 100V) 1.5 pF							50 V	
SL1003A230	184	230	276	600										
SL1003A250	200	250	300		750 850									
SL1003A260	210	260	310				~10 to	300	10 shots					
SL1003A300	240	300	360	750				35 V	shots	(@10kA)	10 A	30 A	135 V	2 kA
SL1003A350	280	350	420	800	900									
SL1003A400	320	400	480	850	950 1000									
SL1003A450	360	450	540	900										
SL1003A500	400	500	600	1100	1400									

Notes:

1. At delivery AQL 0.65 level II, DIN ISO 2859

2. In ionized mode, tested according to ITU-T Rec. K.12

Comparable to the silicon measurement Switching Voltage (Vs)
 Reference REA PE-80, 0.2A. Tested to ITU-T Rec. K.12 and REA PE-80 < 150 msecs.

Product Characteristics

Materials	Leaded Device: Tin-plated copper wire Core and Surface Mount: Dull Tin-plated
Product Marking	Littelfuse 'LF' Mark, voltage and date code

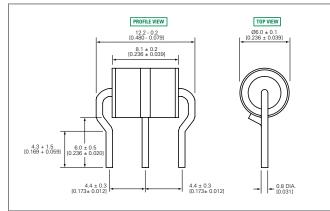
Glow to Arc Transition Current	~1 Amp
Glow Voltage	~60 to 200 Volts
Storage and Operational Temperature	-40 to +90°C



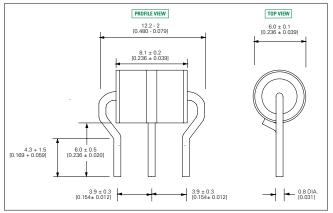
Device Dimensions

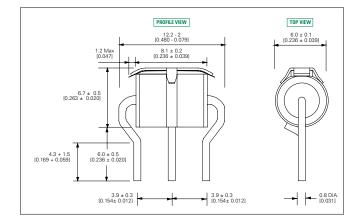
For SL1003A series:

'R' Type Radial Lead Devices (SL1003AxxxR-001)



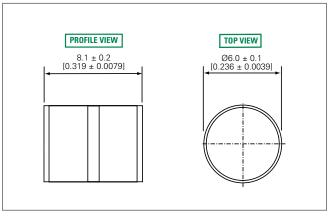
'R' Type Radial Lead Devices (SL1003AxxxR and SL1003AxxxRF)



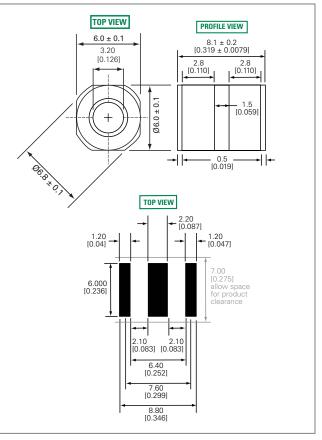


Dimensions are in millimeters [and inches]





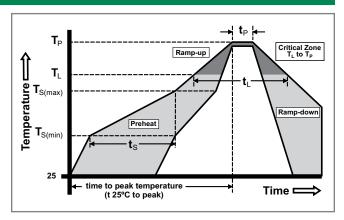
'SM' Type Surface Mount Devices



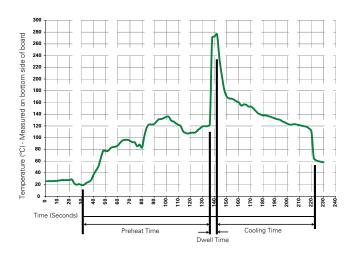


Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb-free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 seconds		
Average R (T _L) to pea	amp-up Rate (LiquidusTemp k)	3°C/second max.		
$T_{S(max)}$ to T_{L}	- Ramp-up Rate	5°C/second max.		
Reflow	-Temperature (T_L) (Liquidus)	217°C		
	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260 ^{+0/-5} °C		
Time with Temperatu	in 5°C of Actual Peak ıre (t _p)	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max.		
Time 25°C	to PeakTemperature (T _P)	8 minutes max.		
Do not exc	ceed	260°C		



Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

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Soldering Parameters - Hand Soldering

Solder Iron Temperature: 350° C +/- 5°C Heating Time: 5 seconds max.

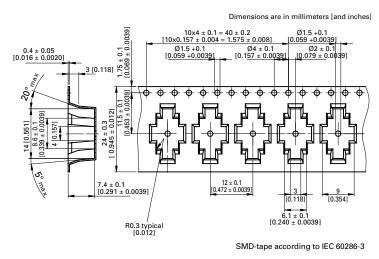


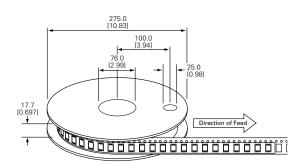
Packaging

'C' Type Core Items: Package bulk pack in polybag, 500 pcs/bag

'R' and 'RF' Type Radial Lead Items: Packed in tray, 100 pcs/tray

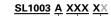
'SM' Type Surface Mount Items: Packaged tape and reel carrier, 700 pcs/reel (specifications below)





Dimensions are in millimeters [and inches]

Part Numbering System and Ordering Information



Type 3 Pole Arrestor

Voltage

Pin Configuration

- C = Core type (Packed in polybag, 500pcs/bag)
 R = Radial Lead without Failsafe (Packed in tray, 100pcs/tray)
 RF = Radial Lead with Failsafe (Packed in tray, 100pcs/tray)
- SM = Surface Mount (Packed in carrier and tape, 700pcs/reel)